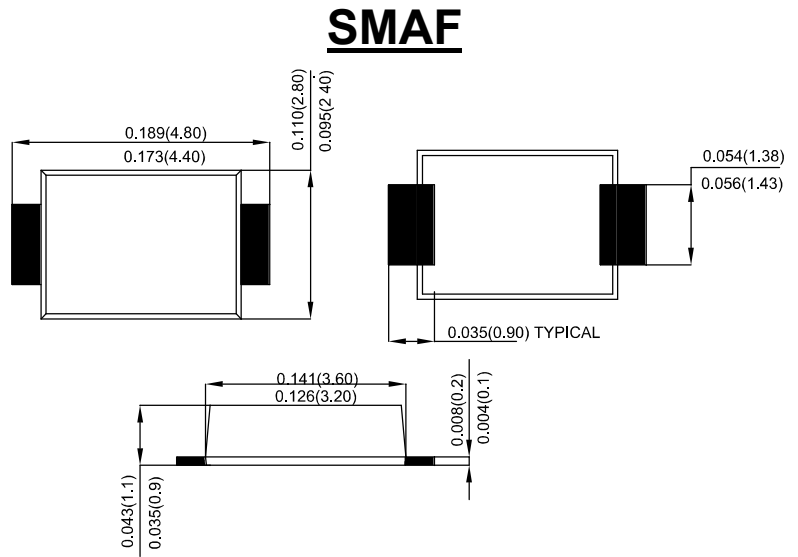


Features

- For surface mounted application
- Low forward voltage drop
- High current capability
- High reliability
- Classification Rating 94V-0

Mechanical Data

- Case: Molded plastic SMAF
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Making: Type Number



Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load

For capacitive load derate current by 20%

Type Number	SYMBOL	G1A	G1B	G1D	G1G	G1J	G1K	G1M	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Average Rectified Output Current @ $T_L=100^\circ\text{C}$	I_o	0.8							A
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Forward Voltage @ $I_F=1.0\text{A}$	V_{FM}	1.1							V
Peak Reverse Current @ $T_A=25^\circ\text{C}$	I_R	5.0							uA
At Rated DC Blocking Voltage @ $T_A=100^\circ\text{C}$		500							
Typical Junction Capacitance (Note 1)	C_J	12							pF
Typical Thermal Resistance Junction to Ambient (Note 2)	$R_{\theta JA}$	30							$^\circ\text{C}/\text{W}$
Operating Temperature Range	T_J	-55 to +150							$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150							$^\circ\text{C}$

- Note:
1. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C
 2. Resistance from Junction to Ambient at 0.375(9.5mm) lead length .

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

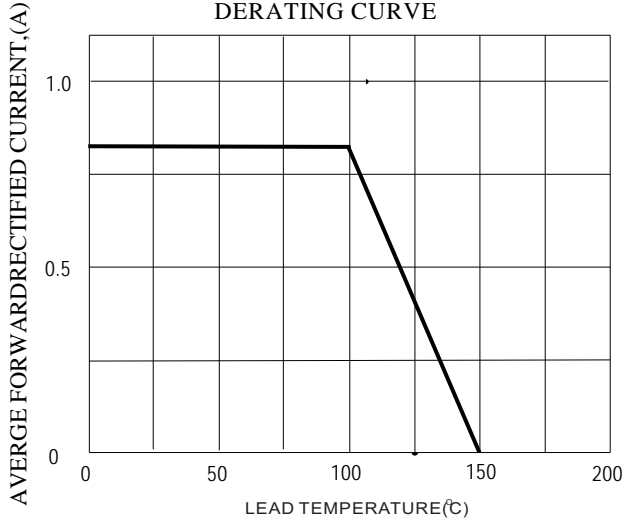


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

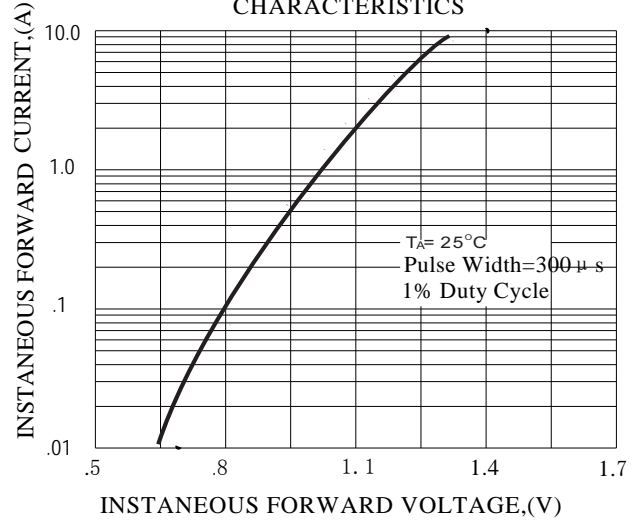


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

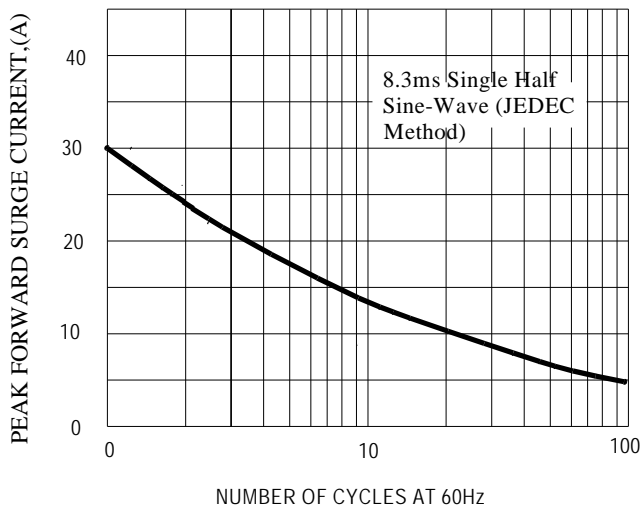


FIG.4-TYPICAL REVERSE CHARACTERISTICS

